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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant: Xiaowei Deng, et al. Docket Number: TI-33969
Serial No.: **10/618,473** Art Unit: 2824
Filed: 07/11/03 Examiner: Van Thu T. Nguyen
For: System for Reducing Row Periphery Power Consumption
in Memory Devices

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NAME OF INVENTOR(S):	
Xiaowei Deng, et al.	
TITLE OF INVENTION: System for Reducing Row Periphery Power Consumption in Memory Devices	
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